

CLAIMS

1. A electronically erasable read only memory, comprising:
a capacitor comprising:
a diffusion layer of a first conductivity type formed in a well of a
5 second conductivity type;
an insulating layer overlying the diffusion layer; and
a floating gate overlying the diffusion layer; and
a MOS transistor comprising:
first and second active regions formed in the well, adjacent to an
10 extended portion of the floating gate.
2. The electronically erasable read only memory of claim 1 wherein
the first conductivity type is a p type and the second conductivity type is an n
type.
3. The electronically erasable read only memory of claim 1 wherein
15 the first conductivity type is an n type and the second conductivity type is a p
type.
4. The electronically erasable read only memory of claim 1 and
further comprising a second diffusion layer beneath one of the first and second
active regions.
- 20 5. The electronically erasable read only memory of claim 4 wherein
the first active regions comprises a source, the second active region comprises a
drain, and the extended portion the floating gate comprises a gate of a MOS
transistor, and the second diffusion layer is formed beneath the second active
region.
- 25 6. A method of forming an electronically erasable read only memory,
comprising the steps of:

forming a diffusion layer of a first conductivity type formed in a well of a second conductivity type;

forming an insulating layer overlying the diffusion layer; and

forming a floating gate overlying the diffusion layer; and

5 forming first and second active regions formed in the well, adjacent to an extended portion of the floating gate.

7. The method of claim 6 wherein the step of forming a diffusion layer comprises the step of forming a diffusion layer of a p conductivity type in a well of an n conductivity type.

10 8. The method of claim 6 wherein the step of forming a diffusion layer comprises the step of forming a diffusion layer of an n conductivity type in a well of a p conductivity type.

9. The method of claim 6 and further comprising the step of forming a second diffusion layer beneath one of the first and second active regions.

15 10. The method of claim 9 wherein the first active region comprises a source, the second active region comprises a drain, and the extended portion the floating gate comprises a gate of a MOS transistor, and wherein the step of forming a second diffusion layer comprises the step of forming the second diffusion layer beneath the second active region.